



Notification of Product/Process Change

Doc. No.: 1623009

This letter intends as a formal notification of change to products which are currently supplied by ROHM Co., Ltd.

ROHM Co., Ltd. requires customers to provide acknowledgment of the receipt of this notification within 30 days from the date of this notice. Lack of acknowledgment of this notice within 30 days is considered as acceptance of the change.

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.

Your understanding and cooperation would be highly appreciated.

Issue Date: May 19, 2023

Title of change	Material change of mold package products (wafer coat [polyimide material] model number change)	
Affected product(s)	Manufacturer part number	Customer part number
	Refer to PN List	Refer to PN List
Detailed description of change	Before	After
	Microsystems PI2727	Microsystems HD4104
Reason for change	LAPIS uses PI2727 polyimide material manufactured by HD Microsystems, Inc. We have received an EOL notice from HD Microsystems.	
Anticipated impact on form, fit, function, quality or reliability	We verify and evaluated the change points and confirmed that there was no problem with the quality.	
Identification of change	It can be examined by marking lot number.	
Planned first ship date	October 31, 2023	
Qualification plan schedule, results and samples	If required, please contact the local ROHM sales office or the authorized distributor.	
Comments	After the delivery date of the prototype lot is fixed, we will finalize plans for electrical characterization and reliability testing and report them to you in due course.	
Supplier contact	Please contact the local ROHM sales office or the authorized distributor.	
Notes		